

### Three-Terminal Adjustable Output Negative Voltage Regulator

The LM337 is an adjustable 3–terminal negative voltage regulator capable of supplying in excess of 1.5 A over an output voltage range of -1.2 V to -37 V. This voltage regulator is exceptionally easy to use and requires only two external resistors to set the output voltage. Further, it employs internal current limiting, thermal shutdown and safe area compensation, making it essentially blow–out proof.

The LM337 serves a wide variety of applications including local, on card regulation. This device can also be used to make a programmable output regulator, or by connecting a fixed resistor between the adjustment and output, the LM337 can be used as a precision current regulator.

- Output Current in Excess of 1.5 A
- Output Adjustable between −1.2 V and −37 V
- Internal Thermal Overload Protection
- Internal Short Circuit Current Limiting Constant with Temperature
- Output Transistor Safe

  —Area Compensation
- Floating Operation for High Voltage Applications
- Eliminates Stocking many Fixed Voltages
- Available in Surface Mount D<sup>2</sup>PAK and Standard 3–Lead Transistor Package

## 

- $^*$ C<sub>in</sub> is required if regulator is located more than 4 inches from power supply filter. A 1.0  $\mu$ F solid tantalum or 10  $\mu$ F aluminum electrolytic is recommended.
- $^{**}C_O$  is necessary for stability. A 1.0  $\mu F$  solid tantalum or 10  $\mu F$  aluminum electrolytic is recommeded.

$$V_{out} = -1.25 \text{ V} \left( 1 + \frac{R_2}{R_1} \right)$$

#### **LM337**

# THREE-TERMINAL ADJUSTABLE NEGATIVE VOLTAGE REGULATOR

SEMICONDUCTOR TECHNICAL DATA



Heatsink surface connected to Pin 2.



Pin 1. Adjust 2. V<sub>in</sub> 3. V<sub>out</sub>

**D2T SUFFIX**PLASTIC PACKAGE
CASE 936
(D<sup>2</sup>PAK)



Heatsink surface (shown as terminal 4 in case outline drawing) is connected to Pin 2.

#### ORDERING INFORMATION

Device	Operating Temperature Range	Package
LM337BD2T	$T_J = -40^{\circ} \text{ to } +125^{\circ}\text{C}$ $T_J = 0^{\circ} \text{ to } +125^{\circ}\text{C}$	Surface Mount
LM337BT		Insertion Mount
LM337D2T		Surface Mount
LM337T		Insertion Mount

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#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Input-Output Voltage Differential	V <sub>I</sub> –V <sub>O</sub>	40	Vdc
Power Dissipation Case 221A			
$T_A = +25^{\circ}C$	PD	Internally Limited	W
Thermal Resistance, Junction-to-Ambient	$\theta_{JA}$	65	°C/W
Thermal Resistance, Junction-to-Case	θJC	5.0	°C/W
Case 936 (D <sup>2</sup> PAK)			
$T_A = +25^{\circ}C$	PD	Internally Limited	W
Thermal Resistance, Junction-to-Ambient	θJΑ	70	°C/W
Thermal Resistance, Junction-to-Case	θJC	5.0	°C/W
Operating Junction Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C

#### **ELECTRICAL CHARACTERISTICS** ( $|V_LV_O| = 5.0 \text{ V}; I_O = 0.5 \text{ A for T package}; T_J = T_{low} \text{ to } T_{high} \text{ [Note 1]}; I_{max} \text{ and } P_{max} \text{ [Note 2].)}$

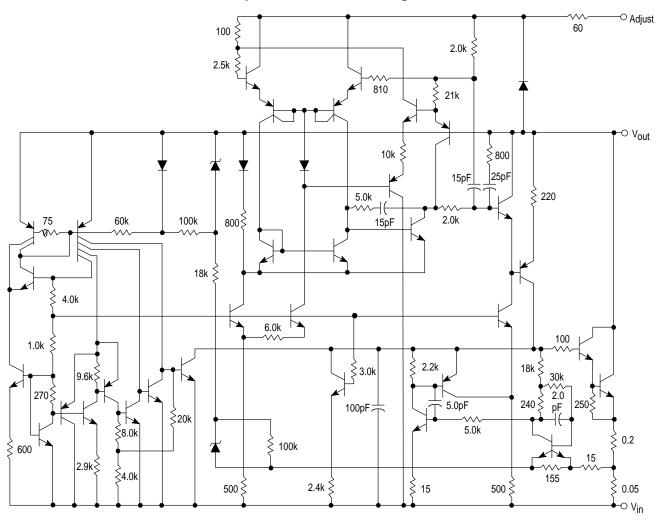
Characteristics	Figure	Symbol	Min	Тур	Max	Unit
Line Regulation (Note 3), $T_A = +25^{\circ}C$ , 3.0 $V \le  V_I - V_O  \le 40 \text{ V}$	1	Reg <sub>line</sub>	_	0.01	0.04	%/V
Load Regulation (Note 3), T <sub>A</sub> = +25°C, 10 mA $\leq$ I <sub>O</sub> $\leq$ I <sub>max</sub>  V <sub>O</sub>   $\leq$ 5.0 V  V <sub>O</sub>   $\geq$ 5.0 V	2	Reg <sub>load</sub>	_ _	15 0.3	50 1.0	mV % VO
Thermal Regulation, T <sub>A</sub> = +25°C (Note 6), 10 ms Pulse		Reg <sub>therm</sub>	_	0.003	0.04	% Vo/W
Adjustment Pin Current	3	l <sub>Adj</sub>	_	65	100	μΑ
Adjustment Pin Current Change, 2.5 V $\leq$  V -V <sub>O</sub>   $\leq$ 40 V, 10 mA $\leq$ I <sub>L</sub> $\leq$ I <sub>max</sub> , P <sub>D</sub> $\leq$ P <sub>max</sub> , T <sub>A</sub> = +25°C	1, 2	ΔlAdj	_	2.0	5.0	μА
Reference Voltage, $T_A$ = +25°C, 3.0 V $\leq$  V <sub>I</sub> -V <sub>O</sub>   $\leq$ 40 V, 10 mA $\leq$ I <sub>O</sub> $\leq$ I <sub>max</sub> , P <sub>D</sub> $\leq$ P <sub>max</sub> , T <sub>J</sub> = T <sub>low</sub> to T <sub>high</sub>	3	V <sub>ref</sub>	-1.213 -1.20	-1.250 -1.25	-1.287 -1.30	V
Line Regulation (Note 3), 3.0 V $\leq$  V <sub>I</sub> -V <sub>O</sub>   $\leq$ 40 V	1	Regline	_	0.02	0.07	%/V
Load Regulation (Note 3), 10 mA $\leq$ I <sub>O</sub> $\leq$ I <sub>max</sub>  V <sub>O</sub>   $\leq$ 5.0 V  V <sub>O</sub>   $\geq$ 5.0 V	2	Regload	_ _	20 0.3	70 1.5	mV % VO
Temperature Stability $(T_{low} \le T_J \le T_{high})$	3	TS	_	0.6	-	% Vo
Minimum Load Current to Maintain Regulation $( V_I-V_O  \le 10 \text{ V})$ $( V_I-V_O  \le 40 \text{ V})$	3	lLmin	_ _	1.5 2.5	6.0 10	mA
Maximum Output Current $  V_I - V_O  \le 15 \text{ V, P}_D \le P_{max}, \text{ T Package} \\  V_I - V_O  \le 40 \text{ V, P}_D \le P_{max}, \text{ T}_J = +25^{\circ}\text{C, T Package} $	3	I <sub>max</sub>	_ _	1.5 0.15	2.2 0.4	А
RMS Noise, % of $V_O$ , $T_A = +25^{\circ}C$ , 10 Hz $\leq$ f $\leq$ 10 kHz		N	_	0.003	_	% Vo
Ripple Rejection, $V_O = -10$ V, $f = 120$ Hz (Note 4) Without $C_{Adj}$ $C_{Adj} = 10  \mu F$	4	RR	_ 66	60 77	- -	dB
Long–Term Stability, $T_J = T_{high}$ (Note 5), $T_A = +25^{\circ}C$ for Endpoint Measurements	3	S	_	0.3	1.0	%/1.0 k Hrs.
Thermal Resistance Junction-to-Case, T Package		$R_{\theta JC}$	_	4.0	-	°C/W

NOTES: 1. T<sub>low</sub> to T<sub>high</sub> = 0° to +125°C, for LM337T, D2T. T<sub>low</sub> to T<sub>high</sub> = -40° to +125°C, for LM337BT, BD2T.
2. I<sub>max</sub> = 1.5 Å, P<sub>max</sub> = 20 W
3. Load and line regulation are specified at constant junction temperature. Change in V<sub>O</sub> because of heating effects is covered under the Thermal Regulation specification. Pulse testing with a low duty cycle is used.

<sup>4.</sup> C<sub>Adj</sub>, when used, is connected between the adjustment pin and ground.
5. Since Long Term Stability cannot be measured on each device before shipment, this specification is an engineering estimate of average stability from lot to lot.

<sup>6.</sup> Power dissipation within an IC voltage regulator produces a temperature gradient on the die, affecting individual IC components on the die. These effects can be minimized by proper integrated circuit design and layout techniques. Thermal Regulation is the effect of these temperature gradients on the output voltage and is expressed in percentage of output change per watt of power change in a specified time.

#### **Representative Schematic Diagram**



This device contains 39 active transistors.

Figure 1. Line Regulation and  $\Delta I_{\mbox{Adj}}/Line$  Test Circuit

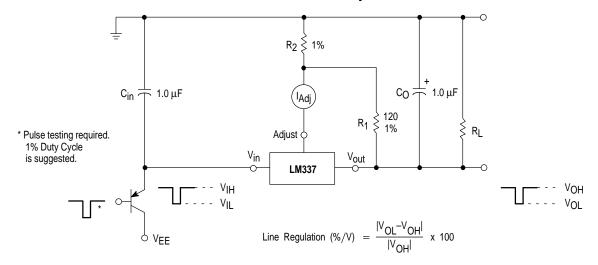


Figure 2. Load Regulation and AlAdi/Load Test Circuit

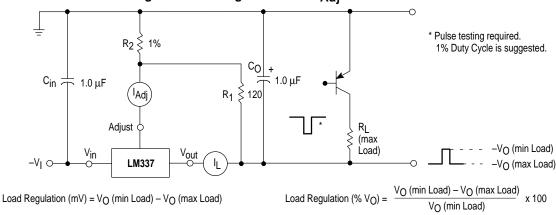


Figure 3. Standard Test Circuit

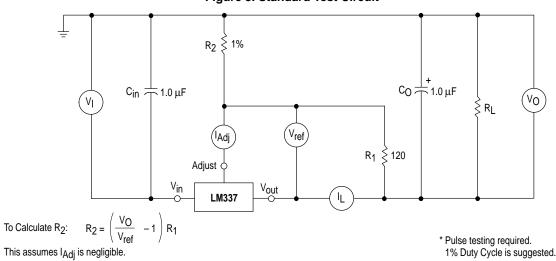
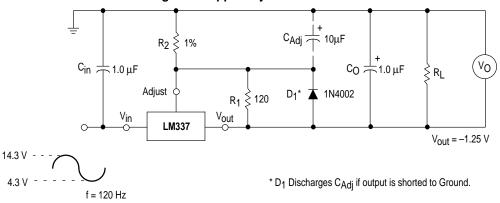
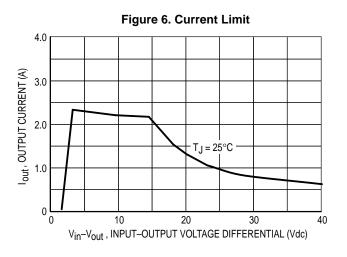


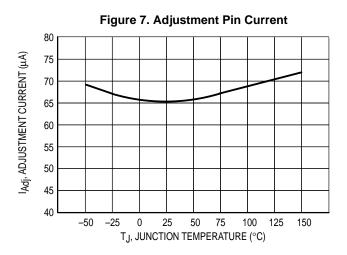
Figure 4. Ripple Rejection Test Circuit

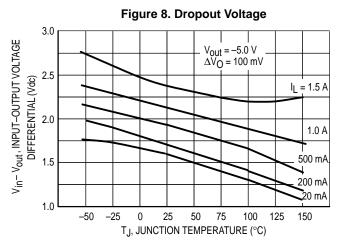


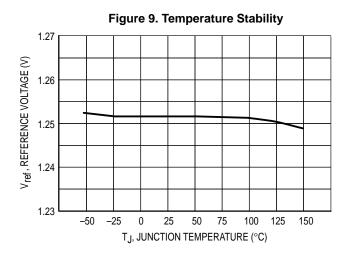
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Figure 5. Load Regulation 0.2  $\Delta V_{\mbox{\scriptsize out}}$  , OUTPUT VOLTAGE CHANGE (%)  $I_{L} = 0.5 A$ -0.4 -0.6 -0.8 I<sub>L</sub> = 1.5 A  $V_{in} = -15 \text{ V}$ -1.0 $V_{out} = -10 \text{ V}$ -50 75 100 125 25 50 T<sub>J</sub>, JUNCTION TEMPERATURE (°C)









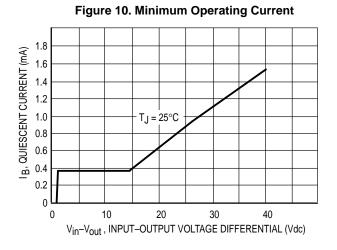


Figure 11. Ripple Rejection versus Output Voltage

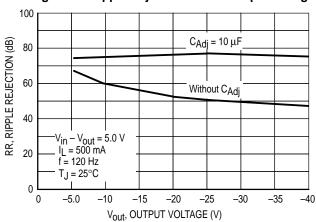


Figure 12. Ripple Rejection versus Output Current

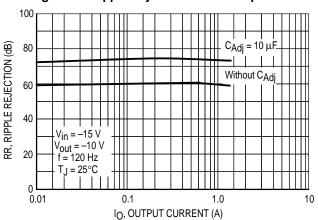


Figure 13. Ripple Rejection versus Frequency

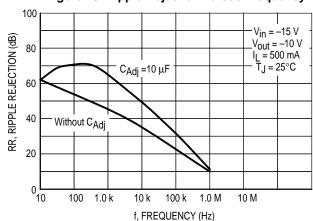


Figure 14. Output Impedance

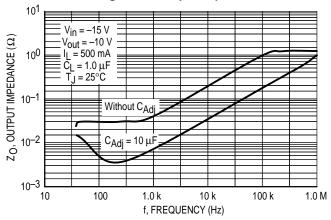


Figure 15. Line Transient Response

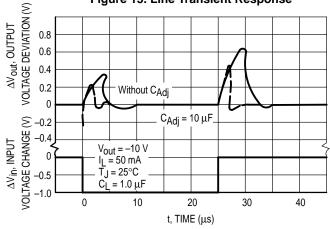
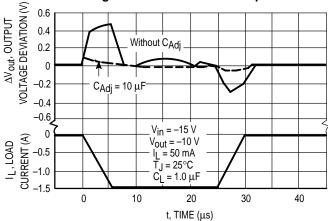


Figure 16. Load Transient Reponse



#### **APPLICATIONS INFORMATION**

#### **Basic Circuit Operation**

The LM337 is a 3–terminal floating regulator. In operation, the LM337 develops and maintains a nominal -1.25 V reference ( $V_{ref}$ ) between its output and adjustment terminals. This reference voltage is converted to a programming current ( $I_{PROG}$ ) by  $R_1$  (see Figure 17), and this constant current flows through  $R_2$  from ground.

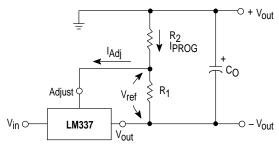
The regulated output voltage is given by:

$$V_{out} = V_{ref} \left( 1 + \frac{R_2}{R_1} \right) + I_{Adj} R_2$$

Since the current into the adjustment terminal ( $I_{Adj}$ ) represents an error term in the equation, the LM337 was designed to control  $I_{Adj}$  to less than 100  $\mu A$  and keep it constant. To do this, all quiescent operating current is returned to the output terminal. This imposes the requirement for a minimum load current. If the load current is less than this minimum, the output voltage will rise.

Since the LM337 is a floating regulator, it is only the voltage differential across the circuit which is important to performance, and operation at high voltages with respect to ground is possible.

Figure 17. Basic Circuit Configuration



V<sub>ref</sub> = -1.25 V Typical

#### **Load Regulation**

The LM337 is capable of providing extremely good load regulation, but a few precautions are needed to obtain maximum performance. For best performance, the programming resistor ( $R_1$ ) should be connected as close to the regulator as possible to minimize line drops which effectively appear in series with the reference, thereby

degrading regulation. The ground end of  $R_2$  can be returned near the load ground to provide remote ground sensing and improve load regulation.

#### **External Capacitors**

A 1.0  $\mu F$  tantalum input bypass capacitor (Cin) is recommended to reduce the sensitivity to input line impedance.

The adjustment terminal may be bypassed to ground to improve ripple rejection. This capacitor ( $C_{Adj}$ ) prevents ripple from being amplified as the output voltage is increased. A 10  $\mu$ F capacitor should improve ripple rejection about 15 dB at 120 Hz in a 10 V application.

An output capacitance (CO) in the form of a 1.0  $\mu F$  tantalum or 10  $\mu F$  aluminum electrolytic capacitor is required for stability.

#### **Protection Diodes**

When external capacitors are used with any IC regulator it is sometimes necessary to add protection diodes to prevent the capacitors from discharging through low current points into the regulator.

Figure 18 shows the LM337 with the recommended protection diodes for output voltages in excess of -25~V or high capacitance values (CO > 25  $\mu\text{F}, \text{C}_{Adj} > 10~\mu\text{F}$ ). Diode D<sub>1</sub> prevents CO from discharging thru the IC during an input short circuit. Diode D<sub>2</sub> protects against capacitor CAdj discharging through the IC during an output short circuit. The combination of diodes D<sub>1</sub> and D<sub>2</sub> prevents CAdj from the discharging through the IC during an input short circuit.

Figure 18. Voltage Regulator with Protection Diodes

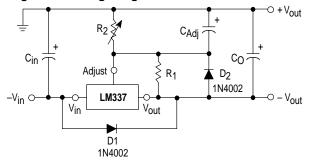
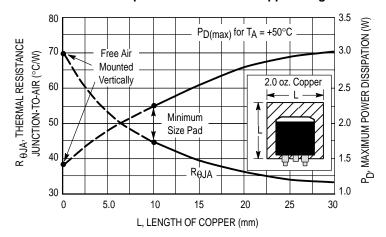
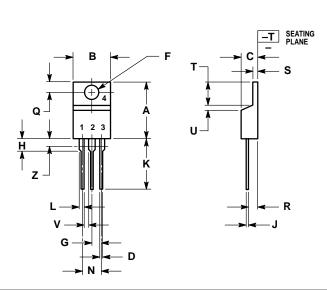


Figure 19. D<sup>2</sup>PAK Thermal Resistance and Maximum Power Dissipation versus P.C.B. Copper Length



#### **OUTLINE DIMENSIONS**

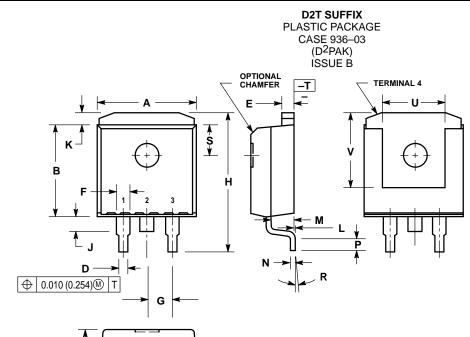




#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI
- DIMENSIONING AND TOLERANGING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH. DIM Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045	_	1.15	
Z	_	0.080	_	2.04



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 114:3M, 1992.
  2 CONTROLLING DIMENSION: INCH.
  3 TAB CONTOUR OPTIONAL WITHIN DIMENSIONS A AND K.
- 4 DIMENSIONS U AND V ESTABLISH A MINIMUM MOUNTING SURFACE FOR TERMINAL 4.
- 5 DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH OR GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS NOT TO EXCEED 0.025 (0.635) MAXIMUM.

	INC	HES	MILLIMETERS			
DIM	MIN	MAX	MIN	MAX		
Α	0.386	0.403	9.804	10.236		
В	0.356	0.368	9.042	9.347		
С	0.170	0.180	4.318	4.572		
D	0.026	0.036	0.660	0.914		
Е	0.045	0.055	1.143	1.397		
F	0.051	0.051 REF		REF		
G	0.100	0.100 BSC		BSC		
Н	0.539	0.579	13.691	14.707		
J	0.125	0.125 MAX		3.175 MAX		
K	0.050	0.050 REF		REF		
L	0.000	0.010	0.000 0.254			
M	0.088	0.102	2.235	2.591		
N	0.018	0.026	0.457	0.660		
P	0.058	0.078	1.473	1.981		
R	5°REF		5°REF			
S	0.116 REF		2.946 REF			
U	0.200 MIN		5.080 MIN			
٧	0.250	MIN	6.350 MIN			

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JAPAN: Nippon Motorola Ltd.; Tatsumi-SPD-JLDC, 6F Seibu-Butsuryu-Center, 3-14-2 Tatsumi Koto-Ku, Tokyo 135, Japan. 03-81-3521-8315

ASIA/PACIFIC: Motorola Semiconductors H.K. Ltd.; 8B Tai Ping Industrial Park, 51 Ting Kok Road, Tai Po, N.T., Hong Kong. 852-26629298

